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ACPL-217

DC Input , Half-Pitch Phototransistor Optocoupler

Data Sheet

Lead (Pb) Free
RoHS 6 fully compliant

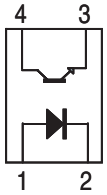
RoHS 6 fully compliant options available;
-xxxE denotes a lead-free product

Description

The ACPL-217 is a DC-input single channel half-pitch phototransistor optocoupler which contains a light emitting diode optically coupled to a phototransistor. It is packaged in a 4-pin SO package.

The input-output isolation voltage is rated at 3000 Vrms. Response time, tr, is 2µs typically, while minimum CTR is 50% at input current of 5 mA

ACPL-217 pin layout



Pin	Description
1	Anode
2	Cathode
3	Emitter
4	Collector

Features

- Current transfer ratio
  (CTR: 50% (min) at I_F = 5mA, V_{CC} = 5V)
- High input-output isolation voltage
  (V_{ISO} = 3,000V_{RMS})
- Non-saturated Response time
  (tr: 2µs (typ) at V_{CC} = 10V, I_C = 2mA, R_L= 100Ω)
- SO package
- CMR 10kV/µs (typical)
- Safety and regulatory approvals
  - cUL
  - IEC/EN/DIN EN 60747-5-2
- Options available:
  – CTR Ranks 0, A, B, C & D

Applications

- I/O Interface for Programmable controllers, computers.
- Sequence controllers
- System appliances, measuring instruments
- Signal transmission between circuits of different potentials and impedances.

Ordering Information

ACPL-217-xxxx is UL Recognized with 3000 Vrms for 1 minute per UL1577 and Canadian Component Acceptance Notice #5.

	RoHS Compliant Option										
Part number	Rank '0' 50% <CTR< 600% I_F=5mA, V_{CE}=5V	Rank 'A' 80% <CTR <160% I_F=5mA, V_{CE}=5V	Rank 'B' 130% <CTR< 260% I_F=5mA, V_{CE}=5V	Rank 'C' 200% <CTR< 400% I_F=5mA, V_{CE}=5V	Rank 'D' 300% <CTR< 600% I_F=5mA V_{CE}=5V	Package	Surface Mount	Tape & Reel	IC Orientation	IEC/EN/DIN EN 60747-5-2	Quantity
ACPL -217	-500E	-50AE	-50BE	-50CE	-50DE	SO-4	x	x	0°		3000 pcs per reel
	-560E	-56AE	-56BE	-56CE	-56DE	SO-4	x	x	0°	X	3000 pcs per reel
	-700E	-70AE	-70BE	-70CE	-70DE	SO-4	x	X	180°		3000 pcs per reel
	-760E	-76AE	-76BE	-76CE	-76DE	SO-4	x	x	180°	X	3000 pcs per reel

To order, choose a part number from the part number column and combine with the desired option from the option column to form an order entry.

Example 1:

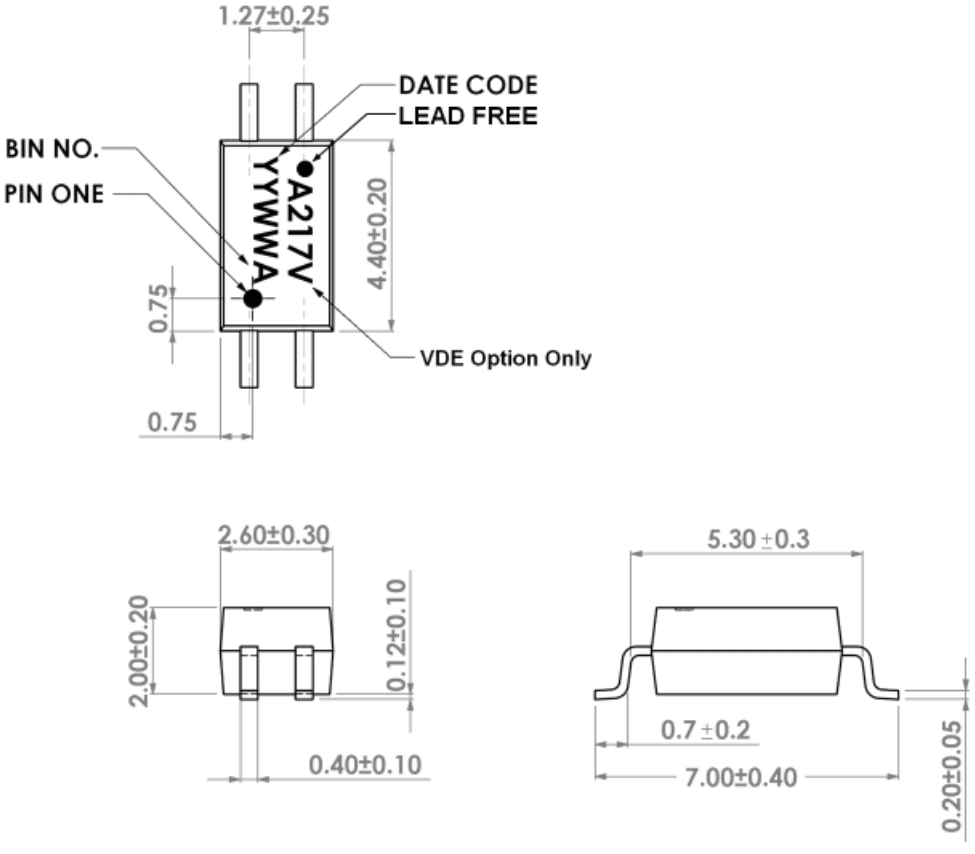
ACPL-217-560E to order product of SO-4 Surface Mount package in Tape & Reel packaging with IEC/EN/DIN EN 60767-5-2 Safety Approval, 50%<CTR<600% and RoHS compliant.

Example 2

ACPL-217-50BE to order product of SO-4 Surface Mount package in Tape & Reel packaging with 130%<CTR<260% and RoHS compliant.

Option datasheets are available. Contact your Avago sales representative or authorized distributor for information.

Package Outline Drawings



Solder Reflow Temperature Profile

Recommended reflow condition as per JEDEC Standard, J-STD-020 (latest revision). Non-Halide Flux should be used.

Absolute Maximum Ratings

Parameter	Symbol	ACPL-217	Units	Note
Storage Temperature	T_S	-55~125	°C	
Operating Temperature	T_A	-55~110	°C	
Average Forward Current	$I_{F(AVG)}$	50	mA	
Pulse Forward Current	I_{FSM}	1	A	
Reverse Voltage	V_R	6	V	
LED Power Dissipation	P_I	65	mW	
Collector Current	I_C	50	mA	
Collector-Emitter Voltage	V_{CEO}	80	V	
Emitter-Collector Voltage	V_{ECO}	7	V	
Isolation Voltage (AC for 1min, R.H. 40~60%)	V_{ISO}	3000	V_{RMS}	1min
Collector Power Dissipation	P_C	150	mW	
Total Power Dissipation	P_{TOT}	200	mW	
Lead Solder Temperature		260°C for 10 seconds		

Electrical Specifications (DC)

Over recommended ambient temperature at 25°C unless otherwise specified.

Parameter	Symbol	Min.	Typ.	Max.	Units	Test Conditions	Note
Forward Voltage	V_F	-	1.2	1.4	V	I_F = 20mA	Fig.6
Reverse Current	I_R	-	-	10	μA	V_R = 5V	
Terminal Capacitance	C_t	-	30	-	pF	V = 0, f = 1MHz	
Collector Dark Current	I_{CEO}	-	-	100	nA	V_{CE} = 48V, I_F = 0 mA	Fig.12
Collector-Emitter Breakdown Voltage	BV_{CEO}	80	-	-	V	I_C = 0.5 mA, I_F = 0 mA	
Emitter-Collector Breakdown Voltage	BV_{ECO}	7	-	-	V	I_E = 100 μA, I_F = 0 mA	
Current Transfer Ratio	CTR	50	-	600	%	I_F = 5 mA, V_{CE} = 5V	CTR=(I_C/IF)* 100%
Saturated CTR	CTR(sat)	-	100	-	%	I_F=1mA, V_{CE} = 0.4V	
Collector-Emitter Saturation Voltage	V_{CE}(sat)	-	-	0.4	V	I_F = 8mA, I_C = 2.4mA	Fig.14
Isolation Resistance	R_{ISO}	$5x10^{10}$	$1x10^{11}$	-	Ω	DC500V, R.H. 40~60%	
Floating Capacitance	C_F	-	0.6	1	pF	V = 0, f = 1MHz	
Cut-off Frequency (-3dB)	F_C	-	80	-	kHz	V_{CC} = 5V, I_C = 2 mA, R_L = 100Ω	Fig. 2,19
Response Time (Rise)	t_r	-	2	-	μs	V_{CC} = 10V, I_C = 2 mA, R_L = 100Ω	Fig. 1
Response Time (Fall)	t_f	-	3	-	μs		
Turn-on Time	t_{on}	-	3	-	μs		
Turn-off Time	t_{off}	-	3	-	μs		
Turn-ON Time	t_{ON}	-	2	-	μs	V_{CC} = 5V, I_F = 16 mA, R_L = 1.9kΩ	Fig. 1, 17
Storage Time	T_S	-	25	-	μs		
Turn-OFF Time	t_{OFF}	-	40	-	μs		
Common Mode Rejection Voltage	CMR	-	10	-	kV/μs	Ta=25°C, R_L=470Ω, V_{CM}=1.5kV(peak), I_F=0mA, V_{CC}=9V, V_{np}=100mV	Fig.20

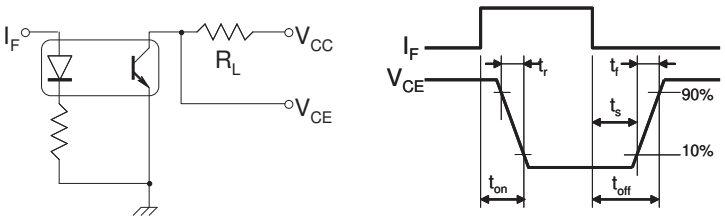


Figure 1. Switching Time Test Circuit

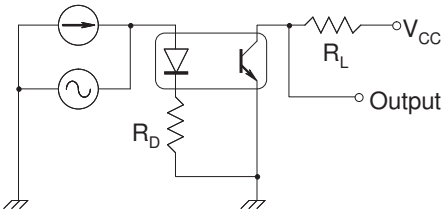


Figure 2. Frequency Response Test Circuit

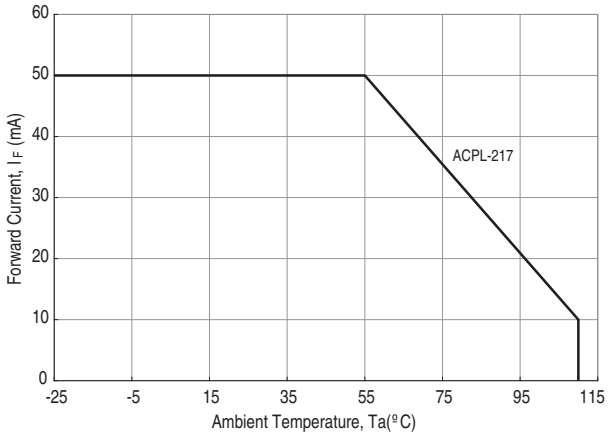


Figure 3. Forward Current vs. Ambient Temperature.

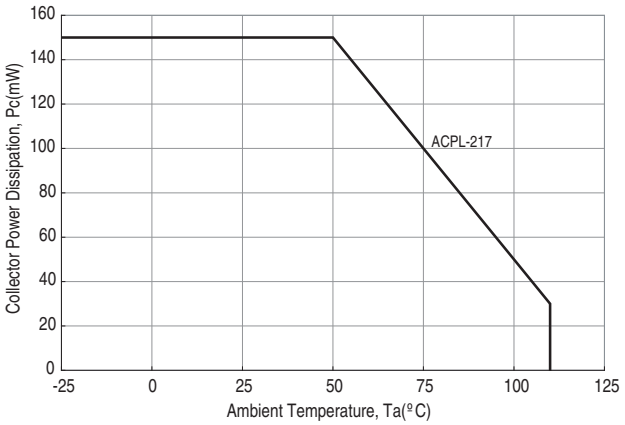


Figure 4. Collector Power Dissipation vs. Ambient Temperature

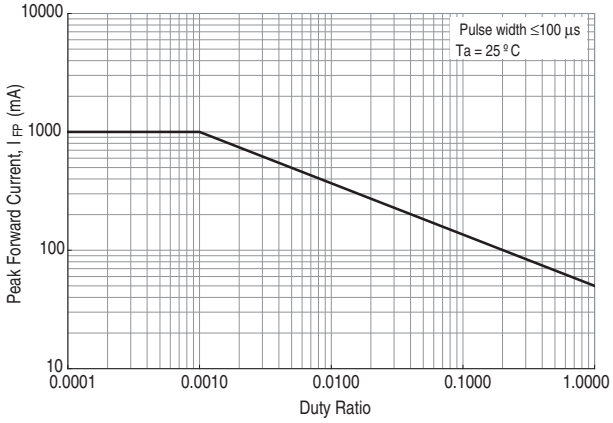


Figure 5. Pulse Forward Current vs. Duty Cycle Ratio

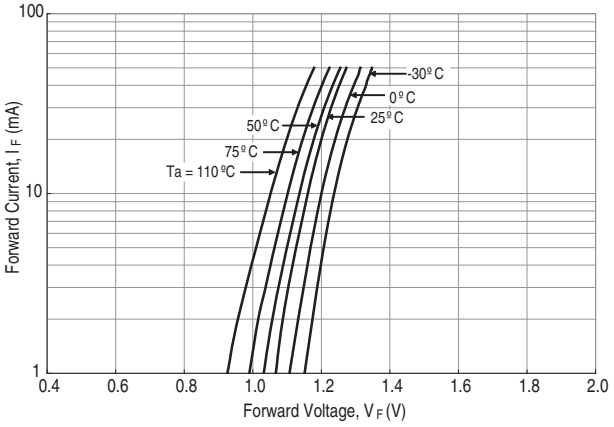


Figure 6. Forward Current vs. Forward Voltage

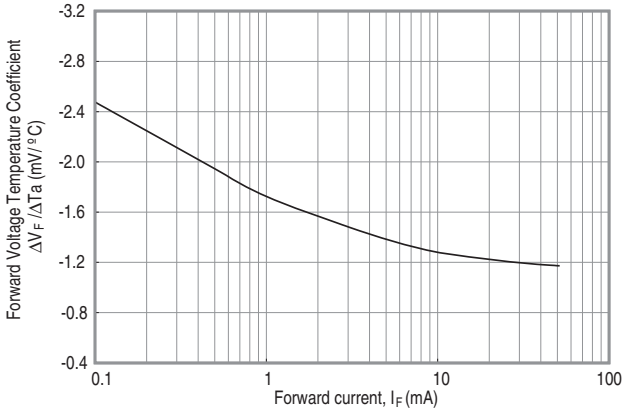


Figure 7. Forward Voltage Temperature Coefficient vs. Forward Current

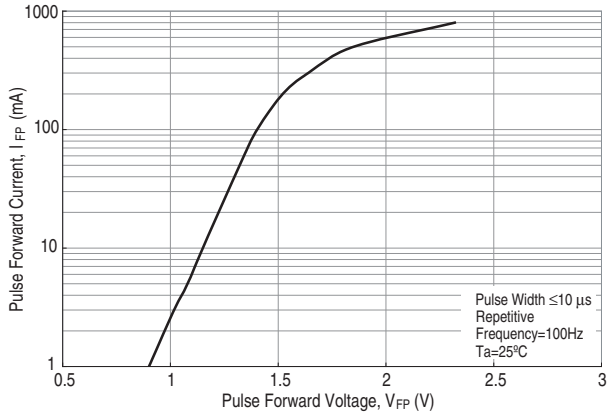


Figure 8. Pulse Forward Current vs. Pulse Forward Voltage

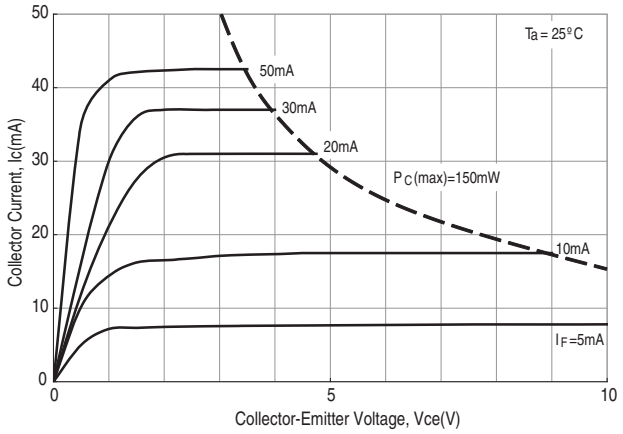


Figure 9. Collector Current vs. Collector-Emitter Voltage

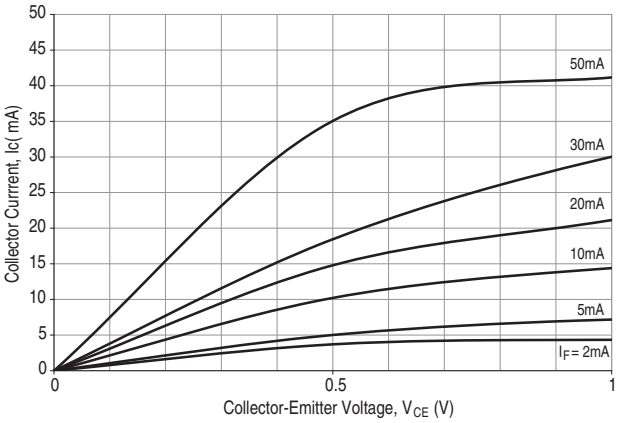


Figure 10. Collector Current vs. Small Collector-Emitter Voltage

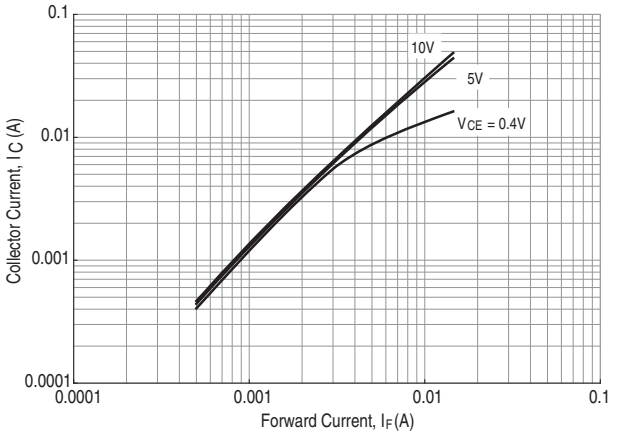


Figure 11. Collector Current vs. Forward Current

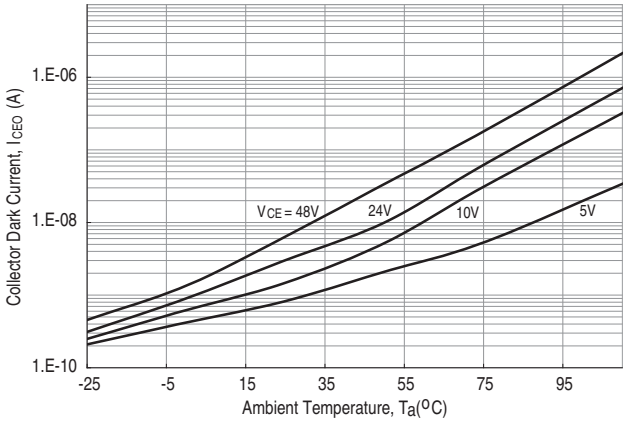


Figure 12. Collector Dark Current vs. Ambient Temperature

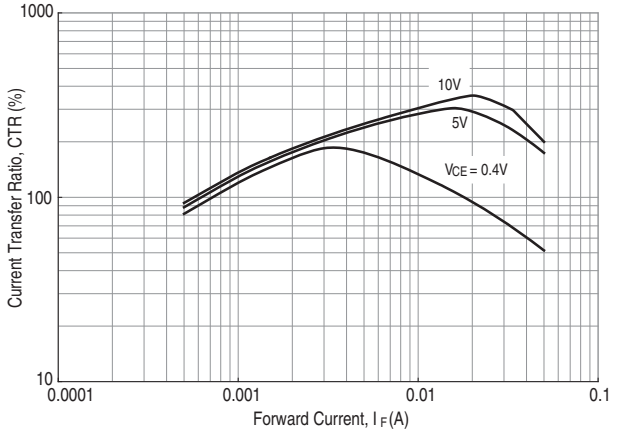


Figure 13. Current Transfer Ratio vs. Forward Current

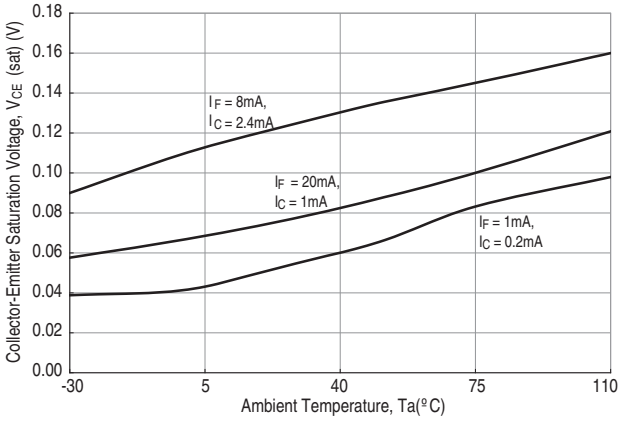


Figure 14. Collector-Emitter Saturation Voltage vs. Ambient Temperature

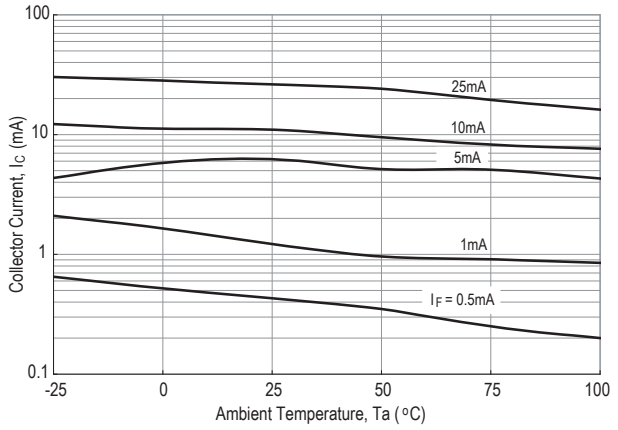


Figure 15. Collector Current vs. Ambient Temperature

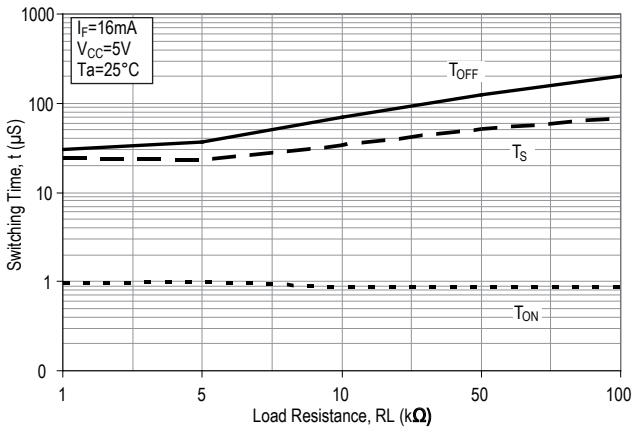


Figure 16. Switching Time vs. Load Resistance

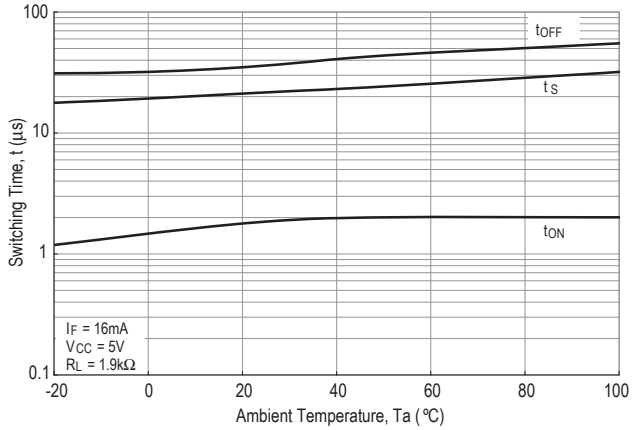


Figure 17. Switching Time vs. Ambient Temperature

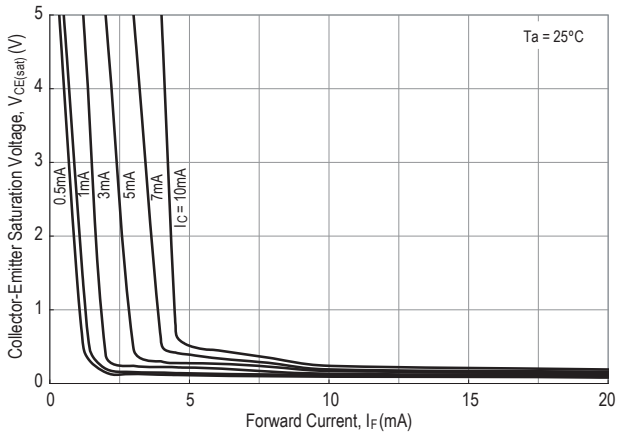


Figure 18. Collector-Emitter Saturation Voltage vs. Forward Current

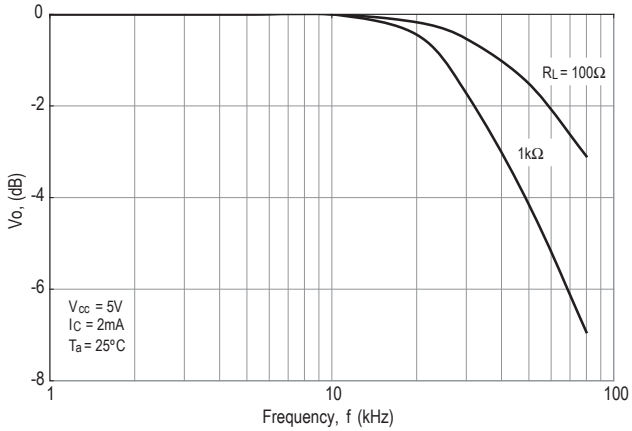


Figure 19. Frequency Response

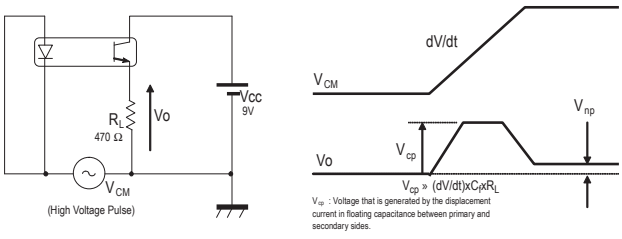


Figure 20. CMR Test Circuit

For product information and a complete list of distributors, please go to our web site: **www.avagotech.com**

AV02-0470EN - August 3, 2011